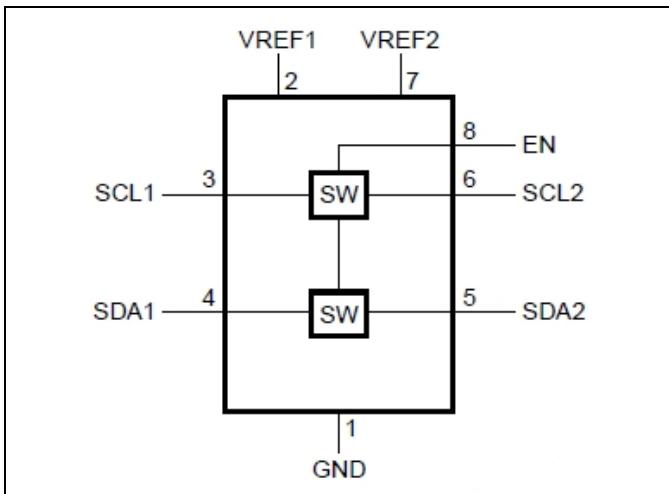


Dual Bidirectional I<sup>2</sup>C-Bus and SMBus Voltage-Level Translator**Description**

The PI3CLS39306 is a dual bidirectional I<sup>2</sup>C-bus, SMBus and I<sup>3</sup>C bus voltage-level translator with an enable (EN) input. It is operational from 0.9V to 3.3V (VREF1) and 1.8V to 5V (VREF2).

The PI3CLS39306 allows bidirectional voltage translations between 1.0V and 5V without the use of a direction pin. The low ON-state resistance ( $R_{on}$ ) of the switch allows connections to be made with minimal propagation delay. When EN is HIGH, the translator switch is on, and the SCL1 and SDA1 I/O are connected to the SCL2 and SDA2 I/O respectively, allowing bidirectional data flow between ports. When EN is LOW, the translator switch is off, and a high-impedance state exists between ports.

**Block Diagram****Table 1. Function Table**

EN	Function
H	SCL1 = SCL2; SDA1 = SDA2
L	disabled

**Features**

- 2-bit Bidirectional Translator for SDA and SCL Lines in Mixed-Mode I<sup>2</sup>C-Bus Applications
- Standard-Mode, Fast-Mode, and Fast-Mode Plus I<sup>2</sup>C-Bus and SMBus Compatible
- I<sup>3</sup>C Compatible (12.5MHz Support)
- Less than 1.5ns Maximum Propagation Delay to Accommodate Standard Mode and Fast Mode I<sup>2</sup>C-Bus Devices and Multiple Masters
- Allows Voltage Level Translation Between:
  - 0.9V VREF1 and 1.8V, 2.5V, 3.3V, or 5V VREF2
  - 1.2V VREF1 and 1.8V, 2.5V, 3.3V, or 5V VREF2
  - 1.5V VREF1 and 2.5V, 3.3V, or 5V VREF2
  - 1.8V VREF1 and 3.3V or 5V VREF2
  - 2.5V VREF1 and 5V VREF2
  - 3.3V VREF1 and 5V VREF2
- Provides Bidirectional Voltage Translation with no Direction Pin
- Low 3.5Ω ON-State Connection Between Input and Output Ports Provides Less Signal Distortion
- Open-Drain I<sup>2</sup>C-Bus I/O Ports (SCL1, SDA1, SCL2, and SDA2)
- 5V Tolerant I<sup>2</sup>C-Bus I/O Ports to Support Mixed-Mode Signal Operation
- High-Impedance SCL1, SDA1, SCL2, and SDA2 Pins for EN = LOW
- Lock-up Free Operation for Isolation when EN = LOW
- Flow through Pinout for Ease of Printed-Circuit Board Trace Routing
- ESD Protection Exceeds 4KV HBM per JESD22-A114
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative.

<https://www.diodes.com/quality/product-definitions/>

- Packaging (Pb-free & Green):
  - 8-Pin, MSOP (M)
  - 8-Pin, VSSOP (V)
  - 8-Pin, SSOP (SS)
  - 8-Pin, SOT28 (TA)
  - 8-Pin, X2-DEN (HK)

## Notes:

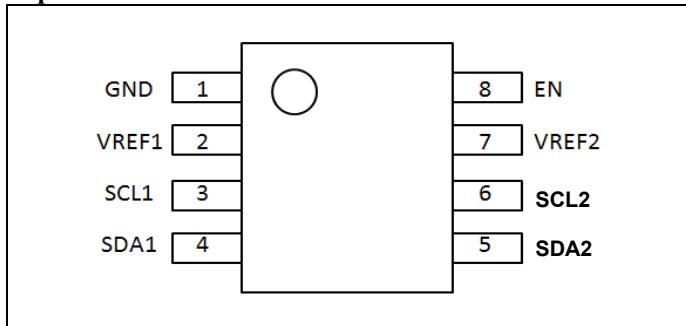
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

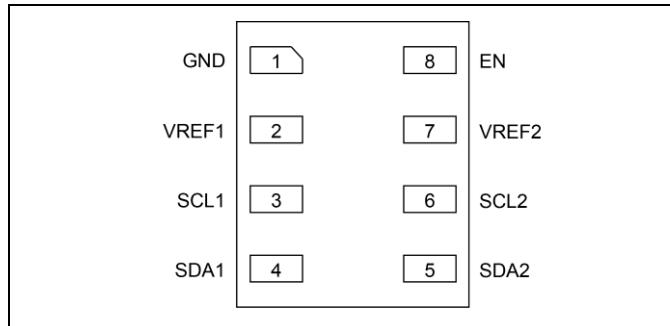
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## Pin Configuration

### Top View



MSOP-8(M)/VSSOP-8(V)/SSOP-8(SS)/SOT28(TA)



X2-DFN-8(HK)

## Pin Description

Pin Number	Pin Name	Description
1	GND	Ground (0V)
2	VREF1	Low-voltage side reference supply voltage for SCL1 and SDA1
3	SCL1	Serial clock, low-voltage side; connect to VREF1 through a pullup resistor
4	SDA1	Serial data, low-voltage side; connect to VREF1 through a pullup resistor
5	SDA2	Serial data, high-voltage side; connect to VREF2 through a pullup resistor
6	SCL2	Serial clock, high-voltage side; connect to VREF2 through a pullup resistor
7	VREF2	High-voltage side reference supply voltage for SCL2 and SDA2
8	EN	Switch enable input; connect to VREF2 and pullup through a high resistor

## Maximum Ratings

Storage Temperature.....	-65°C to +150°C
Reference Voltage <sup>(2)</sup> .....	-0.5V to +6.0V
Reference Bias Voltage.....	-0.5V to +6.0V
DC Input Voltage .....	-0.5V to +6.0V
Control Input Voltage (EN).....	-0.5V to +6.0V
Channel Current (DC).....	128mA
Input Clamping Current.....	-50mA
ESD: HBM Mode .....	4000V
Junction Temperature under Bias (T <sub>j</sub> ) .....	125°C

### Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## Recommended Operation Conditions

V<sub>CC</sub> = 2.7V to 5.5V; GND = 0; T<sub>A</sub> = -40°C to +85°C; unless otherwise specified.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>I/O</sub>	Voltage on an Input/Output Pin	SCL1, SDA1, SCL2, SDA2	0		5	V
V <sub>REF1</sub>	Reference Voltage <sup>(1)</sup>	VREF1	0.9		3.3	V
V <sub>REF2</sub>	Reference Bias Voltage <sup>(2)</sup>	VREF2	1.8		5	V
V <sub>I(EN)</sub>	Input Voltage on Pin EN		0		5	V
I <sub>(pass)</sub>	Pass Switch Current				64	mA
T <sub>A</sub>	Ambient Temperature		-40		85	°C

## DC Electrical Characteristics

T<sub>A</sub> = -40°C to +85°C; unless otherwise specified.

Parameter	Description	Test Conditions <sup>(1)</sup>	Min	Typ. <sup>(2)</sup>	Max	Unit	
<b>Input and Output SDAB and SCLB</b>							
V <sub>IK</sub>	Input Clamping Voltage	I <sub>I</sub> = -18mA; V <sub>I(EN)</sub> = 0			-1.2	V	
I <sub>IH</sub>	HIGH-Level Input Current	V <sub>I</sub> = 5V; V <sub>I(EN)</sub> = 0			5	μA	
C <sub>i(EN)</sub>	Input Capacitance on pin EN	V <sub>I</sub> = 3V or 0		11		pF	
C <sub>io(off)</sub>	Off-State Input/Output Capacitance (SCLn, SDAn)	V <sub>O</sub> = 3V or 0; V <sub>I(EN)</sub> = 0		4		pF	
C <sub>io(on)</sub>	On-State Input/Output Capacitance (SCLn, SDAn)	V <sub>O</sub> = 3V or 0; V <sub>I(EN)</sub> = 3V		10.5		pF	
Ron	ON-State Resistance <sup>(2)</sup> (SCLn, SDAn)	V <sub>I</sub> = 0; I <sub>O</sub> = 64mA	V <sub>I(EN)</sub> = 4.5V		3.5	5.5	Ω
			V <sub>I(EN)</sub> = 3V		4.7	7.0	Ω
			V <sub>I(EN)</sub> = 2.3V		6.3	9.5	Ω
			V <sub>I(EN)</sub> = 1.5V		60	140	Ω
		V <sub>I</sub> = 2.4V; I <sub>O</sub> = 15mA	V <sub>I(EN)</sub> = 4.5V	1	6	15	Ω
			V <sub>I(EN)</sub> = 3V	20	60	140	Ω
		V <sub>I</sub> = 1.7V; I <sub>O</sub> = 15mA	V <sub>I(EN)</sub> = 2.3V	20	60	140	Ω

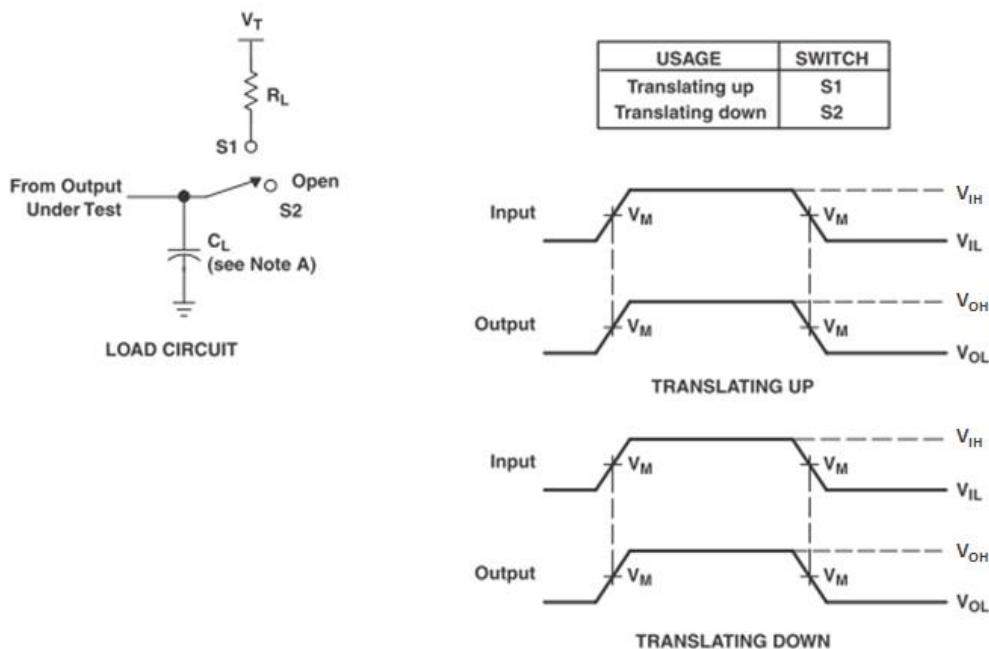
### Notes:

1. All typical values are at T<sub>A</sub> = 25°C.
2. Measured by the voltage drop between the SCL1 and SCL2 or SDA1 and SDA2 terminals at the indicated current through the switch. ON-state resistance is determined by the lowest voltage of the two terminals.

## Dynamic Characteristics

$T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ; unless otherwise specified. Values guaranteed by design.

Symbol	Parameter	Conditions	$C_L = 50\text{pF}$		$C_L = 30\text{pF}$		$C_L = 15\text{pF}$		Unit			
			Min	Max	Min	Max	Min	Max				
Dynamic Characteristics (Translating Down)												
$V_{I(\text{EN})} = 3.3\text{V}$ ; $V_{IH} = 3.3\text{V}$ ; $V_{IL} = 0$ ; $V_M = 1.15\text{V}$												
$t_{PLH}$	LOW-to-HIGH Propagation Delay	From (Input) SCL2 or SDA2 to (Output) SCL1 or SDA1	0	0.8	0	0.6	0	0.3	ns			
$t_{PHL}$	HIGH-to-LOW Propagation Delay	From (Input) SCL2 or SDA2 to (Output) SCL1 or SDA1	0	1.2	0	1	0	0.5	ns			
$V_{I(\text{EN})} = 2.5\text{V}$ ; $V_{IH} = 2.5\text{V}$ ; $V_{IL} = 0$ ; $V_M = 0.75\text{V}$												
$t_{PLH}$	LOW-to-HIGH Propagation Delay	From (Input) SCL2 or SDA2 to (Output) SCL1 or SDA1	0	1	0	0.7	0	0.4	ns			
$t_{PHL}$	HIGH-to-LOW Propagation Delay	From (Input) SCL2 or SDA2 to (Output) SCL1 or SDA1	0	1.3	0	1	0	0.6	ns			
Dynamic Characteristics (Translating up)												
$V_{I(\text{EN})} = 3.3\text{V}$ ; $V_{IH} = 2.3\text{V}$ ; $V_{IL} = 0$ ; $V_T = 3.3\text{V}$ ; $V_M = 1.15\text{V}$ ; $R_L = 300\Omega$												
$t_{PLH}$	LOW-to-HIGH Propagation Delay	From (Input) SCL1 or SDA1 to (Output) SCL2 or SDA2	0	0.9	0	0.6	0	0.4	ns			
$t_{PHL}$	HIGH-to-LOW Propagation Delay	From (Input) SCL1 or SDA1 to (Output) SCL2 or SDA2	0	1.4	0	1.1	0	0.7	ns			
$V_{I(\text{EN})} = 2.5\text{V}$ ; $V_{IH} = 1.5\text{V}$ ; $V_{IL} = 0$ ; $V_T = 2.5\text{V}$ ; $V_M = 0.75\text{V}$ ; $R_L = 300\Omega$												
$t_{PLH}$	LOW-to-HIGH Propagation Delay	From (Input) SCL1 or SDA1 to (Output) SCL2 or SDA2	0	1	0	0.6	0	0.4	ns			
$t_{PHL}$	HIGH-to-LOW Propagation Delay	From (Input) SCL1 or SDA1 to (Output) SCL2 or SDA2	0	1.3	0	1.3	0	0.8	ns			



NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq 2$  ns,  $t_r \leq 2$  ns.  
 C. The outputs are measured one at a time, with one transition per measurement.

**Figure 1. Load Circuit for Outputs**

## Functional Description

The PI3CLS39306 can also be used to run two buses—one at 400kHz operating frequency and the other at 100kHz operating frequency. If the two buses are operating at different frequencies, the 100kHz bus must be isolated when the 400kHz operation of the other bus is required. If the master is running at 400kHz, the maximum system operating frequency may be less than 400kHz because of the delays added by the translator.

As with the standard I<sup>2</sup>C-bus system, pullup resistors are required to provide the logic HIGH levels on the translator's bus. The PI3CLS39306 has a standard open-collector configuration of the I<sup>2</sup>C-bus. Each side of the translator must have a pullup resistor though the size of these pullup resistors depends on the system. The device is designed to work with standard mode, fast mode, and fast mode plus I<sup>2</sup>C-bus devices in addition to SMBus devices.

When the SDA1 or SDA2 port is LOW, the clamp is in the ON-state and a low-resistance connection exists between the SDA1 and SDA2 ports. When the higher voltage is on the SDA2 port, and the SDA2 port is HIGH, the voltage on the SDA1 port is limited to the voltage set by VREF1. When the SDA1 port is HIGH, the SDA2 port is pulled to the drain pullup supply voltage (VDPU) by the pullup resistors. This functionality allows a seamless translation between higher and lower voltages selected by the user without requiring directional control. The SCL1/SCL2 channel also functions as the SDA1/SDA2 channel.

All channels have the same electrical characteristics, and there is minimal deviation from one output to another in voltage or propagation delay. This is a benefit over discrete transistor voltage translation solutions because the fabrication of the switch is symmetrical. The translator provides excellent ESD protection to lower voltage devices, and at the same time protects less ESD-resistant devices.

## Application Information

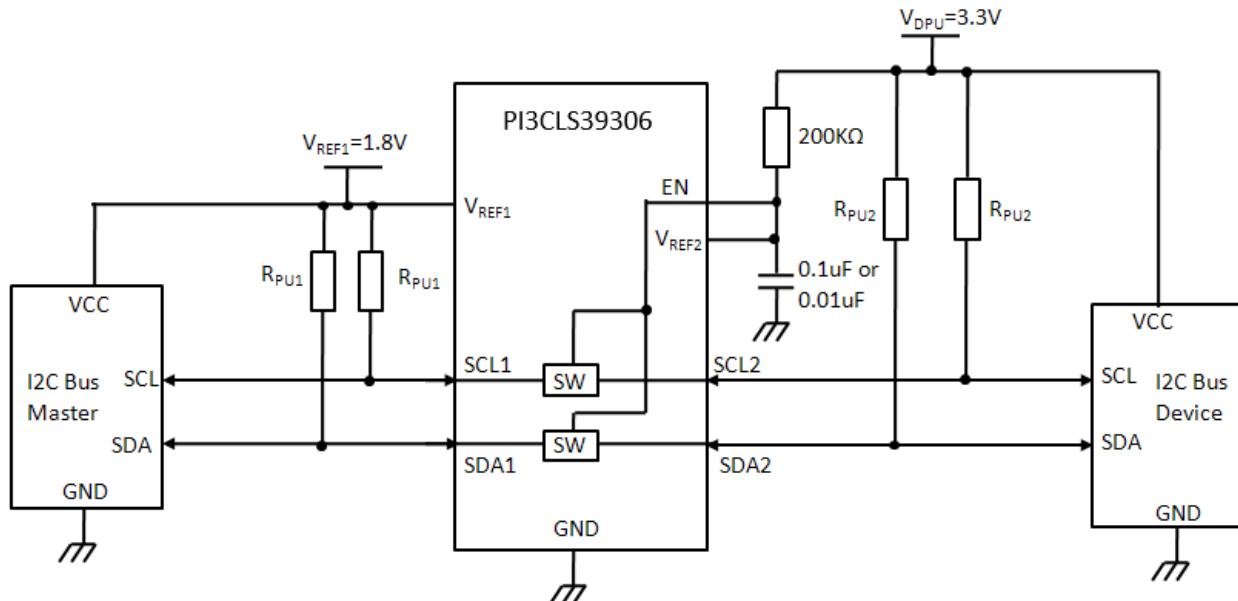


Figure 2. Typical Open-Drain Application Circuit (Switch Always Enabled)

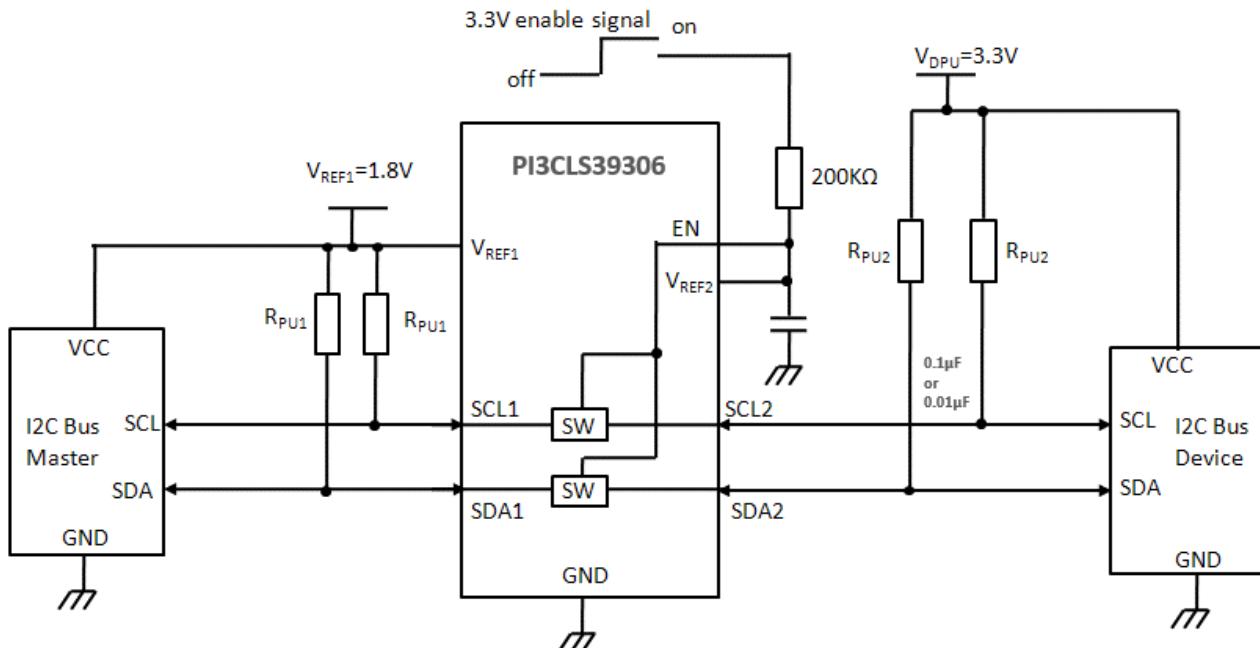
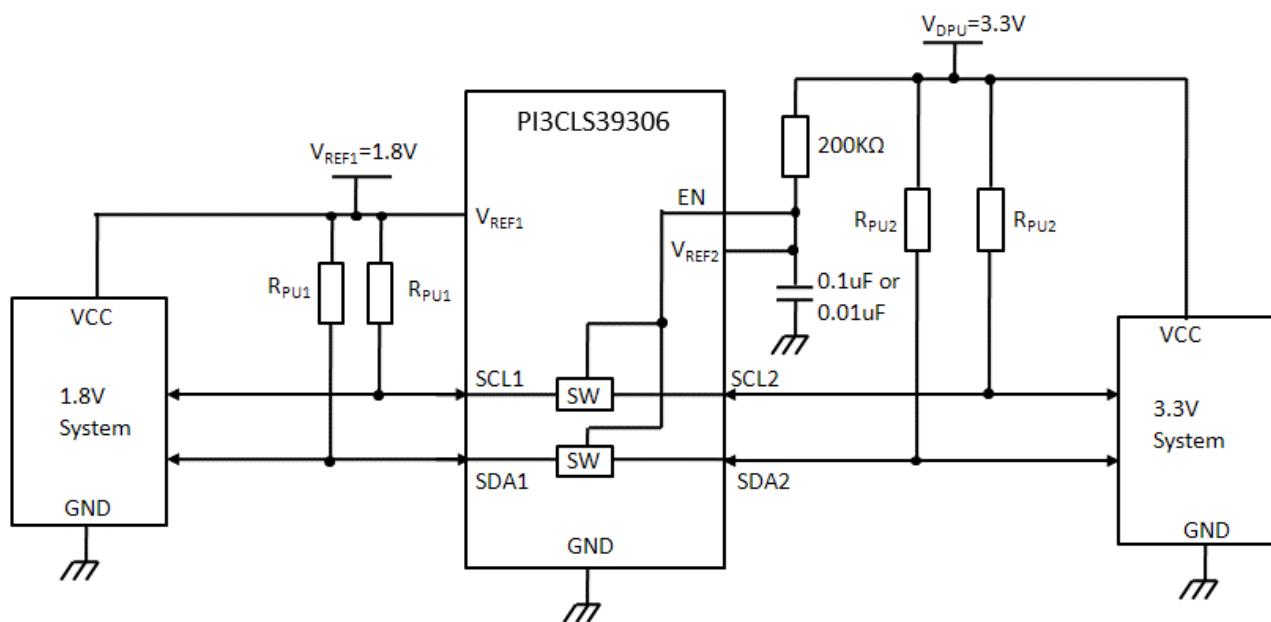


Figure 3. Typical Open-Drain Application Circuit (Switch Enabled Control)

### Open-Drain Application

For the bidirectional clamping configuration (higher voltage to lower voltage or lower voltage to higher voltage), the EN input must be connected to VREF2 and both pins pulled to high-side VDPU through a pullup resistor (typically 200kΩ). This allows VREF2 to regulate the EN input. A filter capacitor on VREF2 is recommended.



**Figure 4. Typical Push-Pull Application Circuit (Switch Enabled Control)**

### Push-Pull Application

If used in push-pull system, the pullup resistors on REF side are also required. The data must be unidirectional, or the outputs must be 3-stateable and controlled by some direction-control mechanism to prevent high-to-low contentions in either direction.

### Operating Voltage

Refer to Figure 2

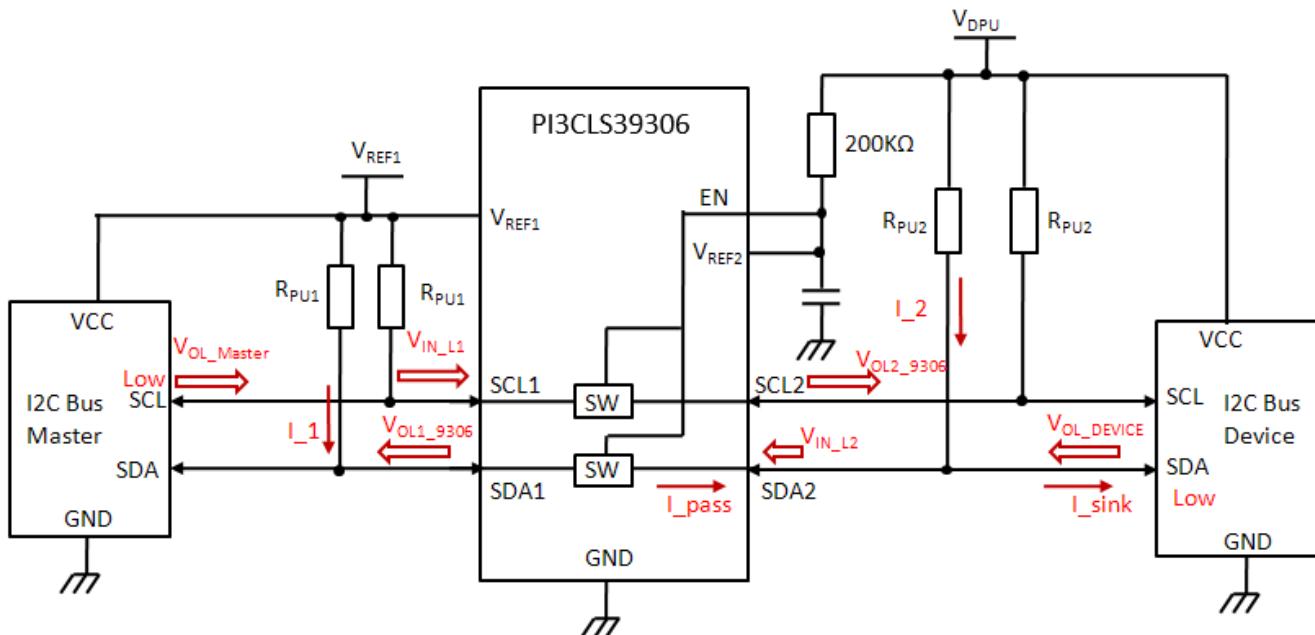
Symbol	Description	Min	Typ <sup>(1)</sup>	Max	Unit
VDPU	Ref2 Side Pullup Voltage on 200kΩ	VREF1 + 0.6	2.1	5	V
EN	Enable Input Voltage	VREF1 + 0.6	2.1	5	V
VREF1	Reference Voltage	0	1.5	4.4	V
IPASS	Pass Switch Current	14			mA
IREF	Reference-Transistor Current			5	µA
TA	Operating Free-Air Temperature	-40		85	°C

### The Pass-Through Current: I\_pass

I\_pass is determined by the pullup and the low voltage added on the PI6LS5V9306.

In Figure 6, I\_pass equals  $(V_{REF1} - V_{OL1\_9306})/R_{PU1}$ .

When V\_IN is 0V, the PI3CLS39306 can support as large as 64mA pass-through current in theory, but it is recommend to limit the I\_pass in 15mA.



**Figure 5. Typical Open-Drain Application Circuit**

### (1) The Sink Current: I<sub>sink</sub>

The device sinks the total current from both pullup resistors. For example, in figure below, when the SDA2 is pulled low by the I2C device, the sink current of the I2C device is  $I_{sink} = I_{pass} + I_2 = I_1 + I_2$ . The same thing happens when I2C master pulls low the I2C bus. The I<sub>sink</sub> should not be larger than the tolerance of the I2C devices.

### (2) V<sub>IL</sub>, V<sub>OL</sub> of the External Drive and V<sub>OL</sub> of PI3CLS39306

In normal application, the V<sub>IL</sub> of external devices should always be larger than the V<sub>OL</sub> of PI3CLS39306. The value of PI3CLS39306's V<sub>OL</sub> is determined by the pass-through current and the low voltage added on the SDA, SCL pins. The  $V_{OL\_9306} = V_{IN\_L} + V_{UP}$  ( $V_{UP}$  is mainly determined by the I<sub>pass</sub>, which is always less than 0.35V).

### (3) Low VREF Application

The PI3CLS39306 can support very-low Vref1 application in theory, but it is recommended no lower than 0.9V. Because when VREF1 is less than 1.8V, the V<sub>OL</sub> of REF1 side is a concern in system. For example, in Figure 6, if VREF1 = 0.9V, VDPU = 3.3V, the V<sub>IL</sub> of the REF1 side I2C master is normally  $0.3 \times VREF1 = 0.25V$ , but the V<sub>OL</sub> of REF2 side can up to  $0.1 \times VDPU = 0.36V$ . The system designer must make sure this situation does not happen. A limit for the V<sub>OL</sub> of REF2 side devices is required then.

The following table shows the requirements for V<sub>OL</sub> of VREF2 side devices when using PI3CLS39306. Figure 6 shows the requirement for V<sub>OL\_DEVICE</sub>.

The V <sub>OL</sub> Requirement of V <sub>REF2</sub> Side External Devices (Temp = 25°C, Assume the V <sub>IL</sub> of V <sub>REF1</sub> Side Devices is $0.3 \times V_{REF1}$ )			
V <sub>REF1</sub>	I <sub>pass</sub>	≤3mA	10mA
0.9V	≤0.15V	≤0.1V	Not Recommended
1.2V	≤0.2V	≤0.15V	Not Recommended
1.5V	≤0.3V	≤0.25V	≤0.2V
1.8V	≤0.4V	≤0.35V	≤0.3V

## Pullup Resistors and Minimum Values

Sizing the pullup resistor on an open-drain bus is specific to the individual application and is dependent on the following driver characteristics:

- The driver sink current
- The  $V_{OL}$  of driver
- The  $V_{OL}$  of the PI3CLS39306
- The  $V_{IL}$  of the driver
- Frequency of operation

The following tables can be used to estimate the pullup resistor value in different use cases so that the minimum resistance for the pullup resistor can be found.

The tables below show suggested minimum values of pullup resistors for the PI3CLS39306 with typical voltage translation levels and drive currents. The calculated values assume that both drive currents are the same.

$V_{OL} = V_{IL} = 0.1 \times V_{CC}$  and accounts for a 5%  $V_{CC}$  tolerance of the supplies, 1% resistor values. Note that the resistor chosen in the final application should be equal to or larger than the values shown in the table to ensure that the pass voltage is less than 10% of the  $V_{CC}$  voltage, and the external driver should be able to sink the total current from both pullup resistors.

Pullup Resistor Minimum Values, 3mA Driver Sink Current for PI3CLS39306

A Side	B Side				
	1.5V	1.8V	2.5V	3.3V	5.0V
<b>0.9V</b>	$R_{RPU1} = 859\Omega$ $R_{RPU2} = 859\Omega$	$R_{RPU1} = 970\Omega$ $R_{RPU2} = 970\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 896\Omega$ or both $1.23k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.19k\Omega$ or both $1.53k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.82k\Omega$ or both $2.16k\Omega$
<b>1.2V</b>	—	$R_{RPU1} = 1.07k\Omega$ $R_{RPU2} = 1.07k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 886\Omega$ or both $1.33k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.18k\Omega$ or both $1.63k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.81k\Omega$ or both $2.26k\Omega$
<b>1.5V</b>	—	—	$R_{RPU1} = \text{none}$ $R_{RPU2} = 875\Omega$ or both $1.43k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.17k\Omega$ or both $1.73k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.8k\Omega$ or both $2.36k\Omega$
<b>1.8V</b>	—	—	$R_{RPU1} = 1.53k\Omega$ $R_{RPU2} = 1.53k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.16k\Omega$ or both $1.82k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.79k\Omega$ or both $2.46k\Omega$
<b>2.5V</b>	—	—	—	$R_{RPU1} = 2.06k\Omega$ $R_{RPU2} = 2.06k\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.77k\Omega$ or both $2.69k\Omega$
<b>3.3V</b>	—	—	—	—	$R_{RPU1} = \text{none}$ $R_{RPU2} = 1.74k\Omega$ or both $2.96k\Omega$

## Pullup Resistor Minimum Values, 10mA Driver Sink Current for PI3CLS39306

A Side	B Side				
	1.5V	1.8V	2.5V	3.3V	5.0V
<b>0.9V</b>	$R_{RPU1} = 258\Omega$ $R_{RPU2} = 258\Omega$	$R_{RPU1} = 291\Omega$ $R_{RPU2} = 291\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 269\Omega$ or both $369\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 358\Omega$ or both $458\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 546\Omega$ or both $646\Omega$
<b>1.2V</b>	—	$R_{RPU1} = 321\Omega$ $R_{RPU2} = 321\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 266\Omega$ or both $399\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 355\Omega$ or both $488\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 543\Omega$ or both $677\Omega$
<b>1.5V</b>	—	—	$R_{RPU1} = \text{none}$ $R_{RPU2} = 263\Omega$ or both $429\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 352\Omega$ or both $518\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 540\Omega$ or both $707\Omega$
<b>1.8V</b>	—	—	$R_{RPU1} = 460\Omega$ $R_{RPU2} = 460\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 348\Omega$ or both $548\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 537\Omega$ or both $737\Omega$
<b>2.5V</b>	—	—	—	$R_{RPU1} = 619\Omega$ $R_{RPU2} = 619\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 521\Omega$ or both $808\Omega$
<b>3.3V</b>	—	—	—	—	$R_{RPU1} = \text{none}$ $R_{RPU2} = 522\Omega$ or both $889\Omega$

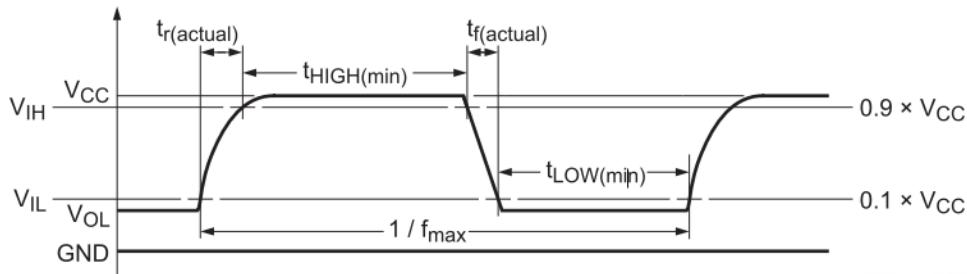
## Pullup Resistor Minimum Values, 15mA Driver Sink Current for PI3CLS39306

A Side	B Side				
	1.5V	1.8V	2.5V	3.3V	5.0V
<b>0.9V</b>	$R_{RPU1} = 172\Omega$ $R_{RPU2} = 172\Omega$	$R_{RPU1} = 194\Omega$ $R_{RPU2} = 194\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 179\Omega$ or both $246\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 238\Omega$ or both $305\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 364\Omega$ or both $431\Omega$
<b>1.2V</b>	—	$R_{RPU1} = 214\Omega$ $R_{RPU2} = 214\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 177\Omega$ or both $266\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 236\Omega$ or both $325\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 362\Omega$ or both $451\Omega$
<b>1.5V</b>	—	—	$R_{RPU1} = \text{none}$ $R_{RPU2} = 175\Omega$ or both $286\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 234\Omega$ or both $345\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 360\Omega$ or both $471\Omega$
<b>1.8V</b>	—	—	$R_{RPU1} = 306\Omega$ $R_{RPU2} = 306\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 232\Omega$ or both $366\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 358\Omega$ or both $492\Omega$
<b>2.5V</b>	—	—	—	$R_{RPU1} = 413\Omega$ $R_{RPU2} = 413\Omega$	$R_{RPU1} = \text{none}$ $R_{RPU2} = 354\Omega$ or both $539\Omega$
<b>3.3V</b>	—	—	—	—	$R_{RPU1} = \text{none}$ $R_{RPU2} = 348\Omega$ or both $593\Omega$

## Maximum Frequency Application

The maximum frequency is limited by the minimum pulse width LOW and HIGH as well as rise time and fall time.

$$f(\max) = \frac{1}{t_{LOW}(\min) + t_{HIGH}(\min) + t_r(\text{actual}) + t_f(\text{actual})}$$



The rise and fall times are dependent upon translation voltages, the drive strength, the total node capacitance (CL), and the pullup resistors (RPU) that are present on the bus. The node capacitance is the addition of the PCB trace capacitance and the device capacitance that exists on the bus.

Because of the dependency of the external components, PCB layout and the different device operating states the calculation of rise and fall times is complex and has several inflection points along the curve.

The main component of the rise and fall times is the RC time constant of the bus line when the device is in its two primary operating states: when device is in the ON state and it is low-impedance and when the device is OFF isolating the A-side from the B-side.

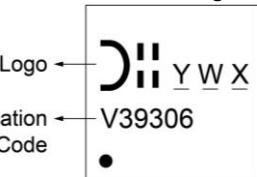
There are some basic guidelines to follow that will help maximize the performance of the device:

- Keep trace length to a minimum by placing the PI3CLS39306 close to the processor.
- The signal round trip time on trace should be shorter than the rise or fall time of signal to reduce reflections.
- The faster the edge of the signal, the higher the chance for ringing.
- The higher drive strength controlled by the pullup resistor (up to 15mA), the higher the frequency the device can use.

The system designer must design the pullup resistor value based on external current drive strength and limit the node capacitance (minimize the wire, stub, connector, and trace length) to get the desired operation frequency result.

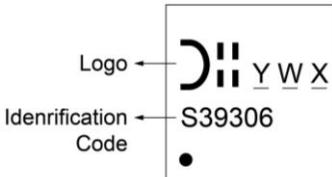
## Part Marking (Top View)

VSSOP Package



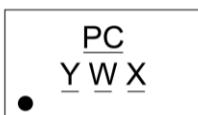
Y: Year: 0 to 9  
W: Week: A to Z: 1 to 26 week;  
 a to z: 27 to 52 week;  
 z represents 52 and 53 week  
X: Internal Code

SSOP Package



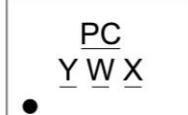
Y: Year: 0 to 9  
W: Week: A to Z: 1 to 26 week;  
 a to z: 27 to 52 week;  
 z represents 52 and 53 week  
X: Internal Code

SOT28 Package



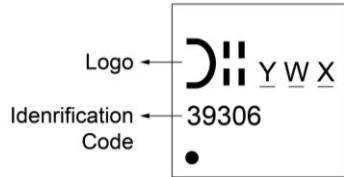
XX: Identification Code  
Y: Year: 0 to 9  
W: Week: A to Z: 1 to 26 week;  
 a to z: 27 to 52 week;  
 z represents 52 and 53 week  
X: Internal Code

HK23 Package



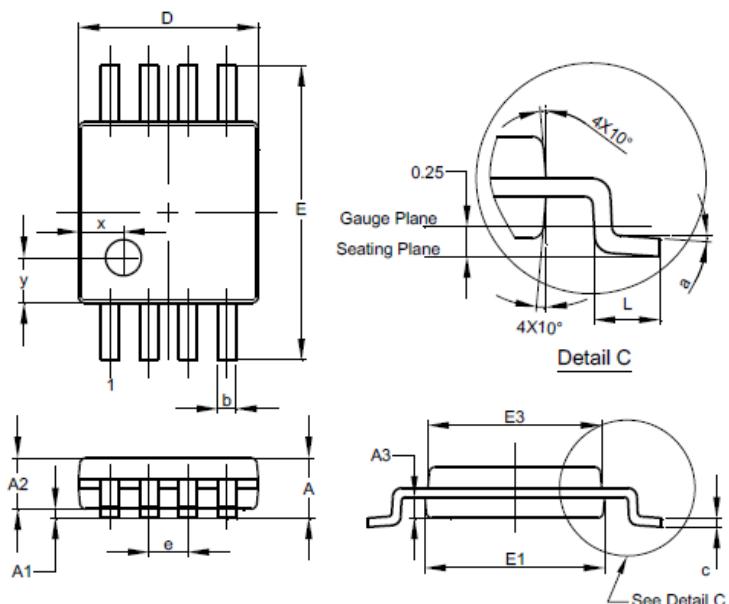
XX: Identification Code  
Y: Year: 0 to 9  
W: Week: A to Z: 1 to 26 week;  
 a to z: 27 to 52 week;  
 z represents 52 and 53 week  
X: Internal Code

MSOP Package



Y: Year: 0 to 9  
W: Week: A to Z: 1 to 26 week;  
 a to z: 27 to 52 week;  
 z represents 52 and 53 week  
X: Internal Code

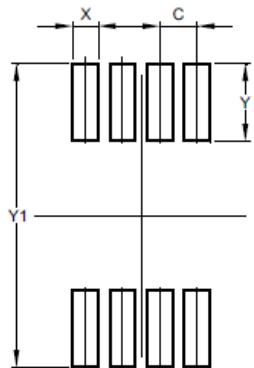
## Packaging Mechanical

**MSOP-8 (M)**
**MSOP-8**


MSOP-8			
Dim	Min	Max	Typ
<b>A</b>	-	1.10	-
<b>A1</b>	0.05	0.15	0.10
<b>A2</b>	0.75	0.95	0.86
<b>A3</b>	0.29	0.49	0.39
<b>b</b>	0.22	0.38	0.30
<b>c</b>	0.08	0.23	0.15
<b>D</b>	2.90	3.10	3.00
<b>E</b>	4.70	5.10	4.90
<b>E1</b>	2.90	3.10	3.00
<b>E3</b>	2.85	3.05	2.95
<b>e</b>	-	-	0.65
<b>L</b>	0.40	0.80	0.60
<b>a</b>	0°	8°	4°
<b>x</b>	-	-	0.750
<b>y</b>	-	-	0.750

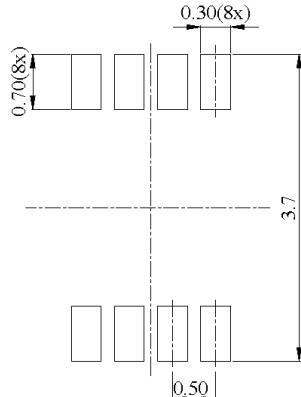
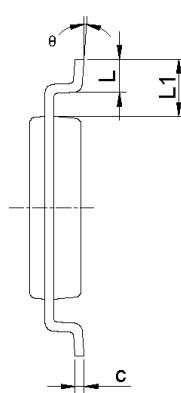
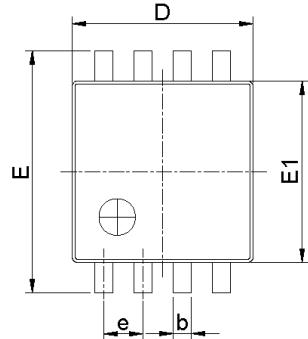
All Dimensions in mm

## Suggested Pad Layout

**MSOP-8**


Dimensions	Value (in mm)
<b>C</b>	0.650
<b>X</b>	0.450
<b>Y</b>	1.350
<b>Y1</b>	5.300

VSSOP-8 (V)

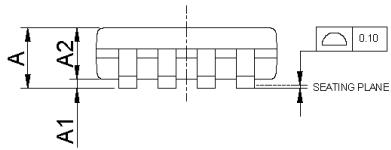


PKG DIMENSIONS(MM)			
SYMBOL	Min.	Nom.	Max.
A	0.60	—	0.90
A1	--	—	0.10
A2	0.60	—	0.80
b	0.17	0.21	0.25
c	0.08	—	0.13
D	1.90	2.00	2.10
E	3.20	3.40	3.60
E1	2.20	2.30	2.40
e	0.50 BSC		
L	0.30	0.35	0.40
L1	0.55 REF		
θ	0°	3°	6°

Top View

Side View

RECOMMENDED LAND PATTERN(unit:mm)



Side View

**NOTE:**  
1. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES IN DEGREES.  
2. REFER JEDEC MO-187F/CA  
3. PACKAGE OUTLINE DIMENSIONS DO NOT INCLUDE MOLD FLASH AND METAL BURR.  
4. LAND PATTERN REFERENCE DIODES MSOP-8 PACKAGE INFORMATION.



DATE: 04/08/21

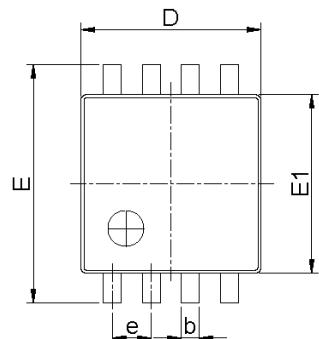
DESCRIPTION: 8-Pin, VSSOP-8L

PACKAGE CODE: V (V8)

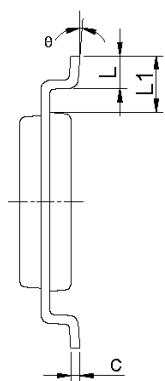
DOCUMENT CONTROL #: PD-2265

REVISION: A

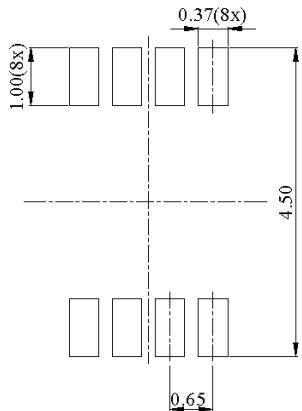
SSOP-8 (SS)



Top View

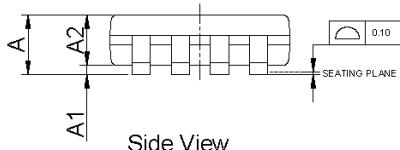


Side View



PKG DIMENSIONS(MM)			
SYMBOL	Min.	Nom.	Max.
A	—	—	1.30
A1	0.05	—	0.15
A2	0.95	1.05	1.20
b	0.15	0.23	0.30
C	0.08	—	0.23
D	2.75	2.95	3.15
E	3.75	4.00	4.25
E1	2.70	2.80	2.90
e	0.65 BSC		
L	0.20	0.40	0.60
L1	0.60 REF		
θ	0°	4°	8°

RECOMMENDED LAND PATTERN(unit:mm)



Side View

**NOTE:**  
 1. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES IN DEGREES.  
 2. REFER JEDEC MO-187F/DA  
 3. PACKAGE OUTLINE DIMENSIONS DO NOT INCLUDE MOLD FLASH AND METAL BURR.  
 4. LAND PATTERN REFERENCE DIODES MSOP-8 PACKAGE INFORMATION.

**DIODES** INCORPORATED **PERICOM** ENABLING SERIAL CONNECTIVITY

DATE: 03/02/21

DESCRIPTION: 8-Pin, SSOP-8L

PACKAGE CODE: SS (SS8)

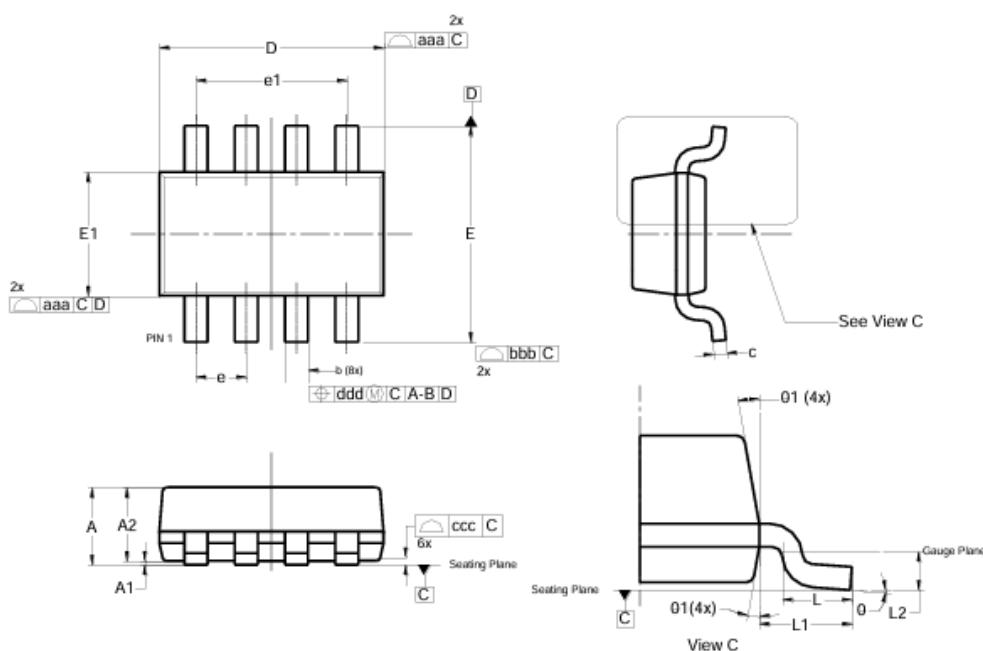
DOCUMENT CONTROL #: PD-2266

REVISION: A

21-1374

SOT28-8 (TA)

SOT28

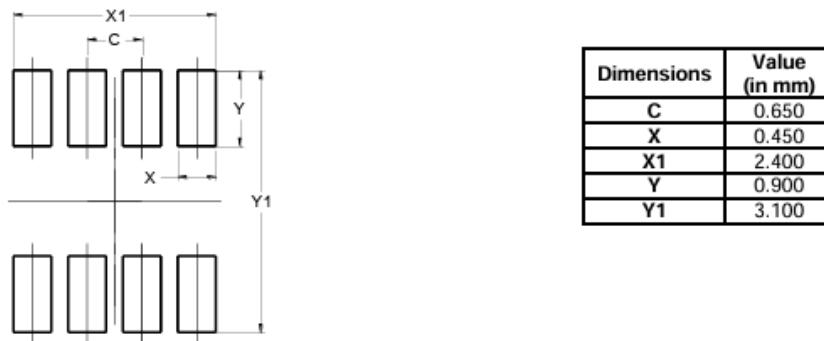


SOT28			
Dim	Min	Max	Typ
<b>A</b>	0.90	1.10	1.00
<b>A1</b>	0.00	0.10	--
<b>A2</b>	--	--	0.95
<b>b</b>	0.20	0.40	0.30
<b>c</b>	0.08	0.20	--
<b>D</b>	2.85	2.95	2.90
<b>E</b>	2.65	2.95	2.80
<b>E1</b>	1.55	1.65	1.60
<b>e</b>	0.65	BSC	
<b>e1</b>	1.95	BSC	
<b>L</b>	0.30	0.60	0.45
<b>L1</b>	0.60	REF	
<b>L2</b>	0.25	BSC	
<b>θ</b>	0°	8°	--
<b>θ1</b>	9°	11°	10°
<b>aaa</b>	0.15		
<b>bbb</b>	0.25		
<b>ccc</b>	0.10		
<b>ddd</b>	0.20		

All Dimensions in mm

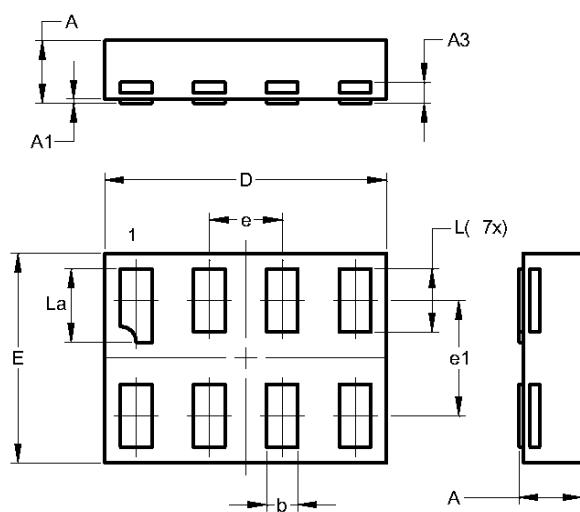
**Suggested Pad Layout**

SOT28



X2-DFN-8 (HK)

X2-DFN1410-8

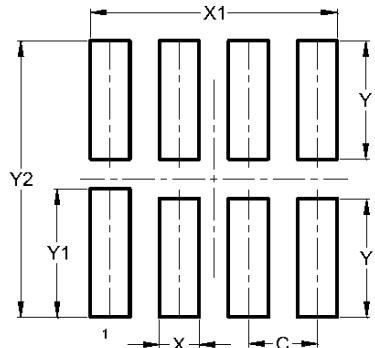


X2-DFN1410-8			
Dim	Min	Max	Typ
A	0.30	0.35	0.33
A1	0.00	0.03	0.02
A3	--	--	0.10
b	0.12	0.20	0.15
D	1.30	1.40	1.35
E	0.95	1.05	1.00
e	--	--	0.35
e1	--	--	0.55
L	0.27	0.35	0.30
L1	0.32	0.40	0.35

All Dimensions in mm

**Suggested Pad Layout**

X2-DFN1410-8



Dimensions	Value (in mm)
C	0.350
X	0.200
X1	1.250
Y	0.600
Y1	0.650
Y2	1.400

**For latest package information:**

See <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>.

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## Mechanical Data

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**MSOP-8 (M)**

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 **(e3)**
- Weight: 0.0246 grams (Approximate)

**VSSOP-8 (V)**

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 **(e3)**
- Weight: 0.011 grams (Approximate)

**SSOP-8 (SS)**

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 **(e3)**
- Weight: 0.0169 grams (Approximate)

**SOT28-8 (TA)**

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 **(e3)**
- Weight: 0.016 grams (Approximate)

**X2-DFN1410-8**

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu Nickel Palladium Gold, Solderable per MIL-STD-202, Method 208 **(e4)**
- Weight: 0.002 grams (Approximate)

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## Ordering Information

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Orderable Part Number	Package Code	Package Description
PI3CLS39306M8-13	M	8-Pin, MSOP
PI3CLS39306V8-7	V	8-Pin, VSSOP
PI3CLS39306SS8-7	SS	8-Pin, SSOP
PI3CLS39306TA8-7	TA	8-Pin, SOT28
PI3CLS39306HK3-7	HK	8-Pin, X2-DFN

**Notes:**

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. E = Pb-free and Green
5. 7 = Tape/Reel size (7"), X suffix = Tape/Reel

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